

Room F (Sicily), 2F

Chair: Yo Nakamura (Fujitsu)

**We3F**

July 1 (Wed), 2026

Coherent Communications & Novel Sources

15:00-16:30

**We3F-1 Invited 15:00-15:30**

**Ultra-Compact Coherent Transmitters for Next-Generation Datacenter Interconnects**

Erwan Weckenmann, Alireza Geravand, Jean-Michel Vallée, Farshid Shateri, Zibo Zheng, Simon Levasseur, Leslie A. Rusch, Wei Shi  
Université Laval

We review our recent works on ultra-compact silicon photonic coherent transmitters, demonstrating record bandwidth density and energy efficiency. Our results, including multi-wavelength and super-channel demonstrations, highlight their scalability for next-generation datacenter interconnects.

**We3F-2 15:30-15:45**

**Temperature Stabilization Technique for Si Micro-Ring-based Coherent QPSK Transmitter**

oungkwan Jo<sup>1,2</sup>, Yongjin Ji<sup>1</sup>, Stefan Lischke<sup>3</sup>, Christian Mai<sup>3</sup>, Lars Zimmermann<sup>3,4</sup>, Woo-Young Choi<sup>1</sup>  
<sup>1</sup>Yonsei University, <sup>2</sup>Electronics and Telecommunications Research Institute, <sup>3</sup>IHP – Leibniz-Institut für innovative Mikroelektronik, <sup>4</sup>Technische Universität Berlin

A temperature stabilization technique is demonstrated for a Si micro-ring-based coherent transmitter operating at 25-Gbaud QPSK. The technique provides initial bias optimization and real-time bias tracking. Its operation is successfully verified through measurement under intentional temperature perturbation.

**We3F-3 15:45-16:00**

**140-Gbaud Lumped-EML Submodule Using a Capacitive Wire-Bonding Pad and LC Resonance**

Seok-Jun Yun<sup>1,2</sup>, Young-Tak Han<sup>1</sup>, Dong-Hoon Lee<sup>1</sup>, Dong-Hyo Lee<sup>1</sup>, Young-Kyu Choi<sup>1</sup>, Hoon Kim<sup>2</sup>, and Yongsoo Baek<sup>1</sup>  
<sup>1</sup>Electronics and Telecommunications Research Institute, <sup>2</sup>Korea Advanced Institute of Science and Technology

We develop a lumped-EML submodule leveraging LC resonance and a capacitive wire-bonding pad to achieve >100-GHz modulation bandwidth. The fabricated submodule demonstrates successful 140-Gbaud PAM-4 and PAM-6 signal transmissions.

**We3F-4 16:00-16:15**

**A Free-Space Optical Communication Link Enabled by Quantum Dot Comb Laser**

Shujie Pan<sup>1,2</sup>, Dingyi Wu<sup>3</sup>, Shihao Ding<sup>4</sup>, Junjie Yang<sup>2</sup>, Xi Xiao<sup>3</sup>, Chao Zhao<sup>1,5</sup>, Siming Chen<sup>1,5</sup>  
<sup>1</sup>Chinese Academy of Sciences, <sup>2</sup>HS Photonics Co., Ltd., <sup>3</sup>National Information Optoelectronics Innovation Center, <sup>4</sup>Shenzhen Technology University, <sup>5</sup>University of Chinese Academy of Science

We demonstrate a 64 Gbit/s/λ free-space optical link using a 100 GHz quantum dot mode-locked laser. This integrated multi-wavelength source is predicted to support distances exceeding 500 m, offering a cost-effective solution for next-generation terrestrial networks.

**We3F-5 16:15-16:30**

**Lasing Characteristics of GaInAsP SCH-MQW High-Mesa LDs Grown on Hydrophilic Bonding InP/Si Substrate**

Qiguang Jia, Zehao Huang, Rong Le, Mizuki Holt, Koki Tominaga, Chaoke Ban, Ruiqi Zhang, Liang Zhao, Kazuhiko Shimomura  
Sophia University

Successful lasing has been achieved in GaInAsP SCH-MQW laser diode of high-mesa structure grown on a hydrophilic bonding InP/Si substrate by MOVPE. The threshold current was comparable with the same structure on InP substrate.